

Vishay Siliconix

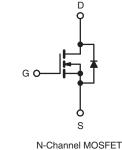
RoHS

COMPLIANT

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	600				
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.60			
Q _g (Max.) (nC)	84				
Q _{gs} (nC)	18				
Q _{gd} (nC)	36				
Configuration	Single				





FEATURES

- Ultra Low Gate Charge
- Reduced Gate Drive Requirement
- Enhanced 30 V V_{GS} Rating
- Reduced C_{iss}, C_{oss}, C_{rss}
- Isolated Central Mounting Hole
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

This new series of low charge Power MOSFETs achieve significantly lower gate charge over conventional MOSFETs. Utilizing advanced Power MOSFET technology the device improvements allow for reduced gate drive requirements, faster switching speeds and increased total system savings. These device improvements combined with the proven ruggedness and reliability of Power MOSFETs offer the designer a new standard in power transistors for switching applications.

TO-247AC The package preferred for is commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because its isolated mounting hole.

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFPC50LCPbF
	SiHFPC50LC-E3
SnPb	IRFPC50LC
	SiHFPC50LC

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	600	V	
Gate-Source Voltage			V _{GS}	± 30		
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	I _D	11		
		T _C = 100 °C		7.3	A	
Pulsed Drain Current ^a			I _{DM}	44		
Linear Derating Factor				1.5	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	920	mJ	
Repetitive Avalanche Current ^a			I _{AR}	11	A	
Repetitive Avalanche Energy ^a			E _{AR}	19	mJ	
Maximum Power Dissipation	T _C =	25 °C	PD	190	W	
Peak Diode Recovery dV/dt ^c			dV/dt	3.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	- °C	
Soldering Recommendations (Peak Temperature)	for	10 s	-	300 ^d	C	
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 13 mH, $R_g = 25 \Omega$, $I_{AS} = 11 \text{ A}$ (see fig. 12). c. $I_{SD} \le 11 \text{ A}$, dI/dt $\le 100 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 150 \text{ °C}$. d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	- 40 0.24 -						
Case-to-Sink, Flat, Greased Surface	R _{thCS}					°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.65						
	I		I			1		
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherv	vise noted)						
PARAMETER	SYMBOL	1	CONDITIO	ONS	MIN.	TYP.	MAX.	UNIT
Static					1		1	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$) V, I _D = 25	i0 μA	600	-	-	v
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference		•	-	0.59	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}		′ _{GS} , I _D = 25		2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	-	$a_{\rm S} = \pm 20 \rm V$	-	-	-	± 100	nA
5		$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		-	-	25	μA	
Zero Gate Voltage Drain Current	I _{DSS}			-	-	250		
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	1	= 6.6 A ^b	-	-	0.60	Ω
Forward Transconductance	9 _{fs}		00 V, I _D = 6	6.6 A ^b	7.0	-	-	S
Dynamic	0.0				1		1	
Input Capacitance	C _{iss}				-	2300	-	
Output Capacitance	C _{oss}	$\label{eq:GS} \begin{array}{l} V_{GS} = 0 \ V, \\ V_{DS} = 25 \ V, \\ f = 1.0 \ \text{MHz}, \ \text{see fig. 5} \end{array}$		-	270	-	pF	
Reverse Transfer Capacitance	C _{rss}			-	28	-		
Total Gate Charge	Qg			1 A, V _{DS} = 360 V, e fig. 6 and 13 ^b	-	-	84	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V			-	-	18	
Gate-Drain Charge	Q _{gd}		see ng		-	-	36	
Turn-On Delay Time	t _{d(on)}				-	17	-	
Rise Time	tr		00.1/1	44 A	-	32	-	1
Turn-Off Delay Time	t _{d(off)}	$ \begin{array}{l} V_{DD} = 300 \; V, \; I_{D} = 11 \; A \; , \\ R_{q} = 6.2 \; \Omega, \; R_{D} = 30 \; \Omega, \; \text{see fig. } 10^{b} \end{array} $		-	41	-	ns	
Fall Time	t _f				-	26	-	1
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	5.0	-	nH	
Internal Source Inductance	L _S			-	13	-		
Drain-Source Body Diode Characteristic	cs				L			<u> </u>
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	11	A	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	44		
Body Diode Voltage	V _{SD}	$T_J = 25 \text{ °C}, I_S = 11 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	1.4	V	
Body Diode Reverse Recovery Time	t _{rr}	$- T_{J} = 25 \text{ °C}, I_{F} = 11 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^{b}$		-	590	890	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			-	4.5	6.8	μC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn			i-on is doi	minated b	y L _S and	L _D)

Notes

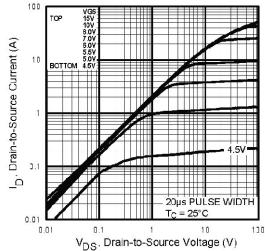
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 1 - Typical Output Characteristics, T_C = 25 °C

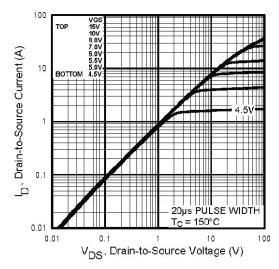


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

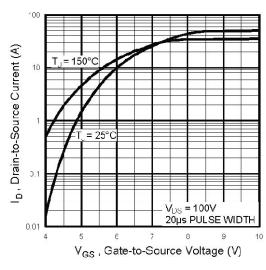


Fig. 3 - Typical Transfer Characteristics

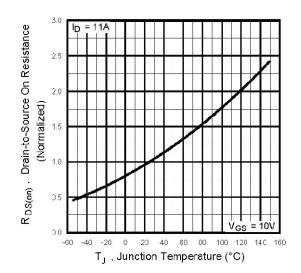


Fig. 4 - Normalized On-Resistance vs. Temperature

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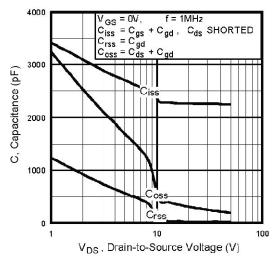


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

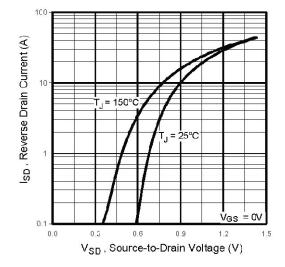


Fig. 7 - Typical Source-Drain Diode Forward Voltage

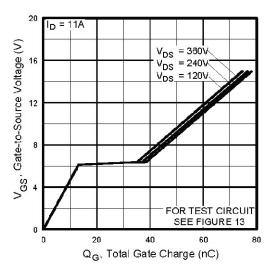


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

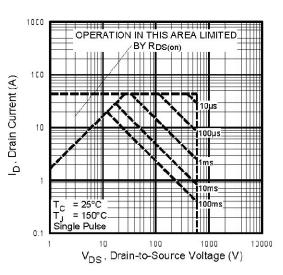


Fig. 8 - Maximum Safe Operating Area

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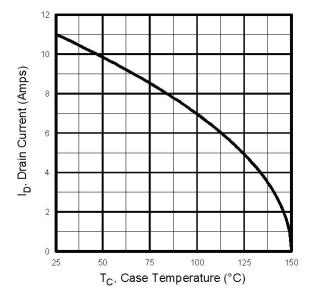


Fig. 9 - Maximum Drain Current vs. Case Temperature

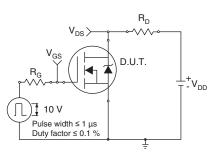


Fig. 10a - Switching Time Test Circuit

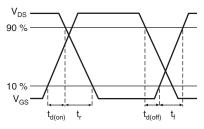


Fig. 10b - Switching Time Waveforms

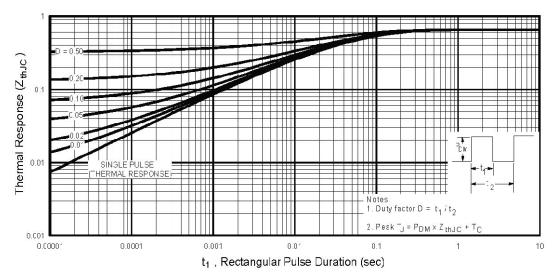


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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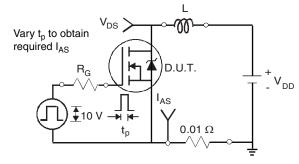
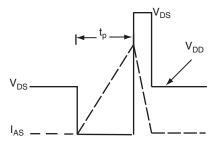
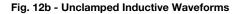


Fig. 12a - Unclamped Inductive Test Circuit





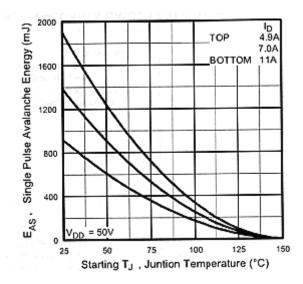
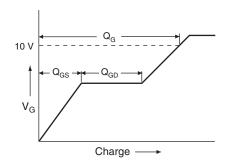


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





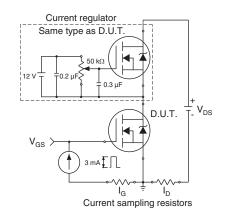
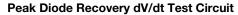


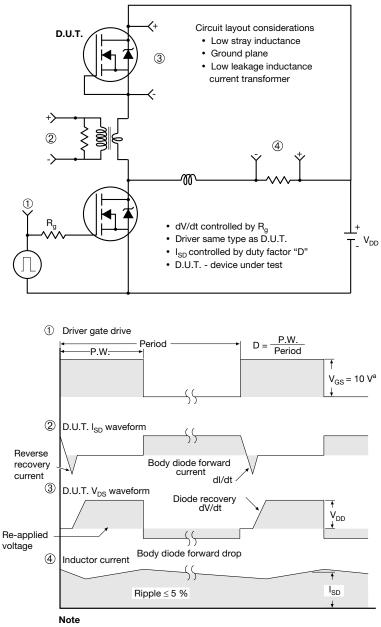
Fig. 13b - Gate Charge Test Circuit

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a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91242.

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